正基科技股份有限公司

SPECIFICATION

SPEC. NO.： _____ REV： 1.0

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PRODUCT NAME： AP6356

	APPROVED	CHECKED	PREPARED	DCC ISSUE
NAME				

AMPAK

AP6356

2x2 WiFi + Bluetooth4.1

Module Spec Sheet

Revision History

Date	Revision Content	Revised By	Version
2014/07/25	-Preliminary	Brian	1.0

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1. Introduction

AMPAK Technology would like to announce a low-cost and low-power consumption module which has all of the WiFi and Bluetooth functionalities. The highly integrated module makes the possibilities of web browsing, VoIP, Bluetooth headsets applications. With seamless roaming capabilities and advanced security, also could interact with different vendors' 802.11a/b/g/n/ac 2x2 Access Points in the wireless LAN.

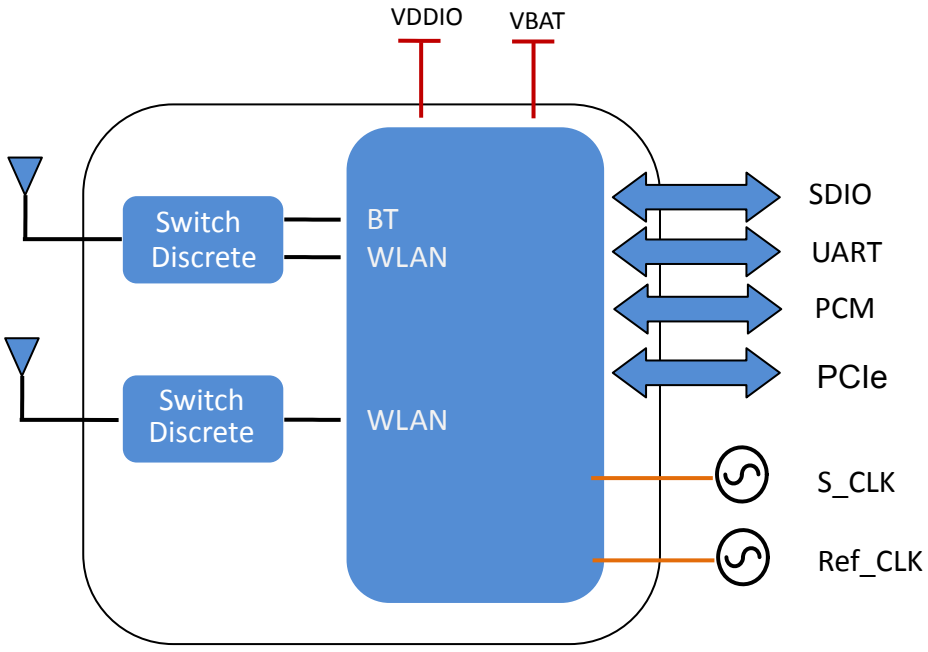
The wireless module complies with IEEE 802.11 a/b/g/n/ac 2x2 MIMO standard and it can achieve up to a speed of 867Mbps with dual stream in 802.11n to connect the wireless LAN. The integrated module provides SDIO/PCIe interface for WiFi, UART / PCM interface for Bluetooth.

This compact module is a total solution for a combination of WiFi + BT technologies. The module is specifically developed for Smart phones and Portable devices.

2. Features

- Lead Free design which is compliant with ROHS requirements.
- 802.11a/b/g/n/ac dual-band radio with virtual-simultaneous dual-band operation
- Dual-stream spatial multiplexing up to 867 Mbps data rate.
- Supports 20, 40, 80 MHz channels with optional SGI(256 QAM modulation)
- Supports IEEE 802.11 ac/n beam forming.
- Supports IEEE 802.15.2 external coexistence interface to optimize bandwidth utilization with other co-located wireless technologies such as LTE, GPS, or WiMAX.
  - Supports standard SDIO/PCIe interfaces.
- BT host digital interface:
  - HCI UART (up to 4 Mbps)
  - PCM for audio data
- Complies with Bluetooth Core Specification Version 4.1 with provisions for supporting future specifications. With Bluetooth Class 1 or Class2 transmitter operation.
- Supports extended synchronous connections (eSCO), for enhanced voice quality by allowing for retransmission of dropped packets.
- Adaptive frequency hopping (AFH) for reducing radio frequency interference.

A simplified block diagram of the module is depicted in the figure below.



3. Deliverables

3.1 Deliverables

The following products and software will be part of the product.

- Module with packaging
- Evaluation Kits
- Software utility for integration, performance test.
- Product Datasheet.
- Agency certified pre-tested report with the adapter board.

3.2 Regulatory certifications

The product delivery is a pre-tested module, without the module level certification. For module approval, the platform's antennas are required for the certification.

4. General Specification

4.1 General Specification

Model Name	AP6356
Product Description	Support WiFi/Bluetooth functionalities
Dimension	L x W x H: 15 x 13 x 1.5 (typical) mm
WiFi Interface	Support SDIO/PCIe
BT Interface	UART / PCM
Operating temperature	-10°C to 65°C
Storage temperature	-40°C to 85°C
Humidity	Operating Humidity 10% to 95% Non-Condensing

4.2 Voltages

4.2.1 Absolute Maximum Ratings

Symbol	Description	Min.	Max.	Unit
VBAT	Input supply Voltage	-0.5	5.5	V
VDDIO	Digital/Bluetooth/SDIO/ I/O Voltage	-0.5	3.8	V

4.2.2 Recommended Operating Rating

The module requires two power supplies: VBAT and VDDIO.

	Min.	Typ.	Max.	Unit
Operating Temperature	-10	25	65	deg.C
VBAT	3.0	3.6	4.8	V
VDDIO	1.7	-	3.6	V

5. WiFi RF Specification

5.1 2.4GHz RF Specification

Conditions : VBAT=3.6V ; VDDIO=3.3V ; Temp:25°C

Feature	Description
WLAN Standard	IEEE 802.11a/b/g/n/ac WiFi compliant
Frequency Range	2.400 GHz ~ 2.497 GHz (2.4 GHz ISM Band)
Number of Channels	2.4GHz：Ch1 ~ Ch14
Modulation	802.11b : DQPSK, DBPSK, CCK 802.11 g/n : OFDM /64-QAM,16-QAM, QPSK, BPSK
Output Power	802.11b /11Mbps : 16 dBm ± 1.5 dB @ EVM ≤ -9dB
	802.11g /54Mbps : 15 dBm ± 1.5 dB @ EVM ≤ -25dB
	802.11n /MCS7 : 14 dBm ± 1.5 dB @ EVM ≤ -28dB
	802.11ac/256-QAM(R=3/4) : 13 dBm ± 1.5 dB @ EVM ≤ -30dB
	802.11ac/256-QAM(R=5/6) : 11 dBm ± 1.5 dB @ EVM ≤ -32dB
SISO Receive Sensitivity (11b,20MHz) @8% PER	- 1Mbps PER @ -94 dBm, typical
	- 2Mbps PER @ -92 dBm, typical
	- 5.5Mbps PER @ -89 dBm, typical
	- 11Mbps PER @ -87 dBm, typical
SISO Receive Sensitivity (11g,20MHz) @10% PER	- 6Mbps PER @ -91 dBm, typical
	- 9Mbps PER @ -90 dBm, typical
	- 12Mbps PER @ -89 dBm, typical
	- 18Mbps PER @ -86 dBm, typical
	- 24Mbps PER @ -83 dBm, typical
	- 36Mbps PER @ -80 dBm, typical
	- 48Mbps PER @ -75 dBm, typical
	- 54Mbps PER @ -73 dBm, typical
MIMO Receive Sensitivity (11g,20MHz) @10% PER	- 6Mbps PER @ -92 dBm, typical
	- 9Mbps PER @ -92 dBm, typical
	- 12Mbps PER @ -91 dBm, typical
	- 18Mbps PER @ -89 dBm, typical
	- 24Mbps PER @ -86 dBm, typical
	- 36Mbps PER @ -83 dBm, typical
	- 48Mbps PER @ -78 dBm, typical
	- 54Mbps PER @ -76 dBm, typical

SISO Receive Sensitivity (11n,20MHz) @10% PER	- MCS=0 PER @ -91 dBm, typical
	- MCS=1 PER @ -88 dBm, typical
	- MCS=2 PER @ -86 dBm, typical
	- MCS=3 PER @ -82 dBm, typical
	- MCS=4 PER @ -79 dBm, typical
	- MCS=5 PER @ -74 dBm, typical
	- MCS=6 PER @ -73 dBm, typical
	- MCS=7 PER @ -71 dBm, typical
MIMO Receive Sensitivity (11n,20MHz) @10% PER	- MCS=0 PER @ -92 dBm, typical
	- MCS=1 PER @ -91 dBm, typical
	- MCS=2 PER @ -89 dBm, typical
	- MCS=3 PER @ -86 dBm, typical
	- MCS=4 PER @ -82 dBm, typical
	- MCS=5 PER @ -77 dBm, typical
	- MCS=6 PER @ -75 dBm, typical
	- MCS=7 PER @ -74 dBm, typical
	- MCS=8 PER @ -89 dBm, typical
	- MCS=15 PER @ -70 dBm, typical
SISO Receive Sensitivity (11n,40MHz) @10% PER	- MCS=0 PER @ -88 dBm, typical
	- MCS=1 PER @ -85 dBm, typical
	- MCS=2 PER @ -83 dBm, typical
	- MCS=3 PER @ -80 dBm, typical
	- MCS=4 PER @ -76 dBm, typical
	- MCS=5 PER @ -72 dBm, typical
	- MCS=6 PER @ -70 dBm, typical
	- MCS=7 PER @ -69 dBm, typical
MIMO Receive Sensitivity (11n,40MHz) @10% PER	- MCS=0 PER @ -90 dBm, typical
	- MCS=1 PER @ -88 dBm, typical
	- MCS=2 PER @ -86 dBm, typical
	- MCS=3 PER @ -83 dBm, typical
	- MCS=4 PER @ -79 dBm, typical
	- MCS=5 PER @ -75 dBm, typical
	- MCS=6 PER @ -73 dBm, typical
	- MCS=7 PER @ -72 dBm, typical
	- MCS=8 PER @ -88 dBm, typical
	- MCS=15 PER @ -69 dBm, typical
SISO Receive	- MCS=0, NSS1 PER @ -90 dBm, typical

Sensitivity (11ac,20MHz) @10% PER	- MCS=1, NSS1 PER @ -87 dBm, typical
	- MCS=2, NSS1 PER @ -86 dBm, typical
	- MCS=3, NSS1 PER @ -82 dBm, typical
	- MCS=4, NSS1 PER @ -79 dBm, typical
	- MCS=5, NSS1 PER @ -74 dBm, typical
	- MCS=6, NSS1 PER @ -72 dBm, typical
	- MCS=7, NSS1 PER @ -71 dBm, typical
	- MCS=8, NSS1 PER @ -68 dBm, typical
MIMO Receive Sensitivity (11ac,20MHz) @10% PER	- MCS=0, NSS1 PER @ -90 dBm, typical
	- MCS=1, NSS1 PER @ -89 dBm, typical
	- MCS=2, NSS1 PER @ -88 dBm, typical
	- MCS=3, NSS1 PER @ -85 dBm, typical
	- MCS=4, NSS1 PER @ -82 dBm, typical
	- MCS=5, NSS1 PER @ -77 dBm, typical
	- MCS=6, NSS1 PER @ -76 dBm, typical
	- MCS=7, NSS1 PER @ -74 dBm, typical
	- MCS=8, NSS1 PER @ -70 dBm, typical
	- MCS=0, NSS2 PER @ -90 dBm, typical
	- MCS=8, NSS2 PER @ -66 dBm, typical
SISO Receive Sensitivity (11ac,40MHz) @10% PER	- MCS=0, NSS1 PER @ -87 dBm, typical
	- MCS=1, NSS1 PER @ -85 dBm, typical
	- MCS=2, NSS1 PER @ -83 dBm, typical
	- MCS=3, NSS1 PER @ -80 dBm, typical
	- MCS=4, NSS1 PER @ -76 dBm, typical
	- MCS=5, NSS1 PER @ -72 dBm, typical
	- MCS=6, NSS1 PER @ -70 dBm, typical
	- MCS=7, NSS1 PER @ -69 dBm, typical
	- MCS=8, NSS1 PER @ -64 dBm, typical
	- MCS=9, NSS1 PER @ -63 dBm, typical
MIMO Receive Sensitivity (11ac,40MHz) @10% PER	- MCS=0, NSS1 PER @ -89 dBm, typical
	- MCS=1, NSS1 PER @ -88 dBm, typical
	- MCS=2, NSS1 PER @ -86 dBm, typical
	- MCS=3, NSS1 PER @ -83 dBm, typical
	- MCS=4, NSS1 PER @ -78 dBm, typical
	- MCS=5, NSS1 PER @ -75 dBm, typical
	- MCS=6, NSS1 PER @ -73 dBm, typical
	- MCS=7, NSS1 PER @ -72 dBm, typical

	- MCS=8, NSS1 PER @ -68 dBm, typical
	- MCS=9, NSS1 PER @ -66 dBm, typical
	- MCS=0, NSS2 PER @ -87 dBm, typical
	- MCS=9, NSS2 PER @ -62 dBm, typical
Maximum Input Level	802.11b : -10 dBm
	802.11g/n : -20 dBm
Antenna Reference	Small antennas with 0~2 dBi peak gain

5.2 5GHz RF Specification

Conditions : VBAT=3.6V ; VDDIO=3.3V ; Temp:25°C

Feature	**Description**
WLAN Standard	IEEE 802.11a/n 2x2, WiFi compliant
Frequency Range	4.900 GHz ~ 5.845 GHz (5.0 GHz ISM Band)
Number of Channels	5.0GHz：Please see the table[1]
Modulation	802.11a : OFDM /64-QAM,16-QAM, QPSK, BPSK 802.11n : OFDM /64-QAM,16-QAM, QPSK, BPSK 802.11ac : OFDM /256-QAM
Output Power	802.11a /54Mbps : 13 dBm ± 1.5 dB @ EVM ≤ -25dB
	802.11n /MCS7 : 12 dBm ± 1.5 dB @ EVM ≤ -28dB
	802.11ac /MCS9 : 10 dBm ± 1.5 dB @ EVM ≤ -32dB
SISO Receive Sensitivity (11a,20MHz) @10% PER	- 6Mbps PER @ -90 dBm, typical
	- 9Mbps PER @ -89 dBm, typical
	- 12Mbps PER @ -88 dBm, typical
	- 18Mbps PER @ -85 dBm, typical
	- 24Mbps PER @ -82 dBm, typical
	- 36Mbps PER @ -79 dBm, typical
	- 48Mbps PER @ -74 dBm, typical
	- 54Mbps PER @ -72 dBm, typical

MIMO Receive Sensitivity (11a,20MHz) @10% PER	- 6Mbps	PER @ -91 dBm, typical
	- 9Mbps	PER @ -91 dBm, typical
	- 12Mbps	PER @ -90 dBm, typical
	- 18Mbps	PER @ -88 dBm, typical
	- 24Mbps	PER @ -85 dBm, typical
	- 36Mbps	PER @ -82 dBm, typical
	- 48Mbps	PER @ -77 dBm, typical
	- 54Mbps	PER @ -73 dBm, typical
SISO Receive Sensitivity (11n,20MHz) @10% PER	- MCS=0	PER @ -90 dBm, typical
	- MCS=1	PER @ -87 dBm, typical
	- MCS=2	PER @ -85 dBm, typical
	- MCS=3	PER @ -82 dBm, typical
	- MCS=4	PER @ -78 dBm, typical
	- MCS=5	PER @ -73 dBm, typical
	- MCS=6	PER @ -72 dBm, typical
	- MCS=7	PER @ -70 dBm, typical
MIMO Receive Sensitivity (11n,20MHz) @10% PER	- MCS=0	PER @ -91 dBm, typical
	- MCS=1	PER @ -90 dBm, typical
	- MCS=2	PER @ -88 dBm, typical
	- MCS=3	PER @ -85 dBm, typical
	- MCS=4	PER @ -81 dBm, typical
	- MCS=5	PER @ -76 dBm, typical
	- MCS=6	PER @ -75 dBm, typical
	- MCS=7	PER @ -73 dBm, typical
	- MCS=8	PER @ -90 dBm, typical
	- MCS=15	PER @ -70 dBm, typical
SISO Receive Sensitivity (11n,40MHz) @10% PER	- MCS=0	PER @ -87 dBm, typical
	- MCS=1	PER @ -84 dBm, typical
	- MCS=2	PER @ -82 dBm, typical
	- MCS=3	PER @ -79 dBm, typical
	- MCS=4	PER @ -75 dBm, typical
	- MCS=5	PER @ -71 dBm, typical
	- MCS=6	PER @ -69 dBm, typical
	- MCS=7	PER @ -68 dBm, typical
MIMO Receive Sensitivity (11n,40MHz) @10% PER	- MCS=0	PER @ -89 dBm, typical
	- MCS=1	PER @ -87 dBm, typical
	- MCS=2	PER @ -85 dBm, typical

	- MCS=3 PER @ -82 dBm, typical
	- MCS=4 PER @ -78 dBm, typical
	- MCS=5 PER @ -74 dBm, typical
	- MCS=6 PER @ -72 dBm, typical
	- MCS=7 PER @ -71 dBm, typical
	- MCS=8 PER @ -87 dBm, typical
	- MCS=15 PER @ -68 dBm, typical
SISO Receive Sensitivity (11ac,20MHz) @10% PER	- MCS=0, NSS1 PER @ -88 dBm, typical
	- MCS=1, NSS1 PER @ -86 dBm, typical
	- MCS=2, NSS1 PER @ -84 dBm, typical
	- MCS=3, NSS1 PER @ -81 dBm, typical
	- MCS=4, NSS1 PER @ -77 dBm, typical
	- MCS=5, NSS1 PER @ -72 dBm, typical
	- MCS=6, NSS1 PER @ -71 dBm, typical
	- MCS=7, NSS1 PER @ -70 dBm, typical
	- MCS=8, NSS1 PER @ -66 dBm, typical
MIMO Receive Sensitivity (11ac,20MHz) @10% PER	- MCS=0, NSS1 PER @ -90 dBm, typical
	- MCS=1, NSS1 PER @ -89 dBm, typical
	- MCS=2, NSS1 PER @ -87 dBm, typical
	- MCS=3, NSS1 PER @ -84 dBm, typical
	- MCS=4, NSS1 PER @ -80 dBm, typical
	- MCS=5, NSS1 PER @ -75 dBm, typical
	- MCS=6, NSS1 PER @ -74 dBm, typical
	- MCS=7, NSS1 PER @ -73 dBm, typical
	- MCS=8, NSS1 PER @ -69 dBm, typical
	- MCS=0, NSS2 PER @ -89 dBm, typical
	- MCS=8, NSS2 PER @ -65 dBm, typical
SISO Receive Sensitivity (11ac,40MHz) @10% PER	- MCS=0, NSS1 PER @ -86 dBm, typical
	- MCS=1, NSS1 PER @ -83 dBm, typical
	- MCS=2, NSS1 PER @ -81 dBm, typical
	- MCS=3, NSS1 PER @ -78 dBm, typical
	- MCS=4, NSS1 PER @ -75 dBm, typical
	- MCS=5, NSS1 PER @ -70 dBm, typical
	- MCS=6, NSS1 PER @ -69 dBm, typical
	- MCS=7, NSS1 PER @ -68 dBm, typical
	- MCS=8, NSS1 PER @ -63 dBm, typical
	- MCS=9, NSS1 PER @ -62 dBm, typical

MIMO Receive Sensitivity (11ac,40MHz) @10% PER	- MCS=0, NSS1 PER @ -88 dBm, typical
	- MCS=1, NSS1 PER @ -86 dBm, typical
	- MCS=2, NSS1 PER @ -84 dBm, typical
	- MCS=3, NSS1 PER @ -81 dBm, typical
	- MCS=4, NSS1 PER @ -78 dBm, typical
	- MCS=5, NSS1 PER @ -73 dBm, typical
	- MCS=6, NSS1 PER @ -72 dBm, typical
	- MCS=7, NSS1 PER @ -71 dBm, typical
	- MCS=8, NSS1 PER @ -66 dBm, typical
	- MCS=9, NSS1 PER @ -65 dBm, typical
	- MCS=0, NSS2 PER @ -86 dBm, typical
	- MCS=9, NSS2 PER @ -61 dBm, typical
SISO Receive Sensitivity (11ac,80MHz) @10% PER	- MCS=0, NSS1 PER @ -83 dBm, typical
	- MCS=1, NSS1 PER @ -80 dBm, typical
	- MCS=2, NSS1 PER @ -78 dBm, typical
	- MCS=3, NSS1 PER @ -74 dBm, typical
	- MCS=4, NSS1 PER @ -71 dBm, typical
	- MCS=5, NSS1 PER @ -68 dBm, typical
	- MCS=6, NSS1 PER @ -66 dBm, typical
	- MCS=7, NSS1 PER @ -64 dBm, typical
	- MCS=9, NSS1 PER @ -60 dBm, typical
	- MCS=9, NSS1 PER @ -58 dBm, typical
MIMO Receive Sensitivity (11ac,80MHz) @10% PER	- MCS=0, NSS1 PER @ -84 dBm, typical
	- MCS=1, NSS1 PER @ -83 dBm, typical
	- MCS=2, NSS1 PER @ -81 dBm, typical
	- MCS=3, NSS1 PER @ -77 dBm, typical
	- MCS=4, NSS1 PER @ -74 dBm, typical
	- MCS=5, NSS1 PER @ -71 dBm, typical
	- MCS=6, NSS1 PER @ -69 dBm, typical
	- MCS=7, NSS1 PER @ -67 dBm, typical
	- MCS=8, NSS1 PER @ -63 dBm, typical
	- MCS=9, NSS1 PER @ -61 dBm, typical
	- MCS=0, NSS2 PER @ -82 dBm, typical
	- MCS=9, NSS2 PER @ -57 dBm, typical
Maximum Input Level	802.11a/n : -30 dBm
Antenna Reference	Small antennas with 0~2 dBi peak gain

[1]5GHz(20MHz) Channel table

Band (GHz)	Operating Channel Numbers	Channel center frequencies(MHz)
5.15GHz~5.25GHz	36	5180
	40	5200
	44	5220
	48	5240
5.25GHz~5.35GHz	52	5260
	56	5280
	60	5300
	64	5320
5.5GHz~5.7GHz	100	5500
	104	5520
	108	5540
	112	5560
	116	5580
	120	5600
	124	5620
	128	5640
	132	5660
	136	5680
	140	5700
5.725GHz~5.825GHz	149	5745
	153	5765
	157	5785
	161	5805

6. Bluetooth Specification

6.1 Bluetooth Specification

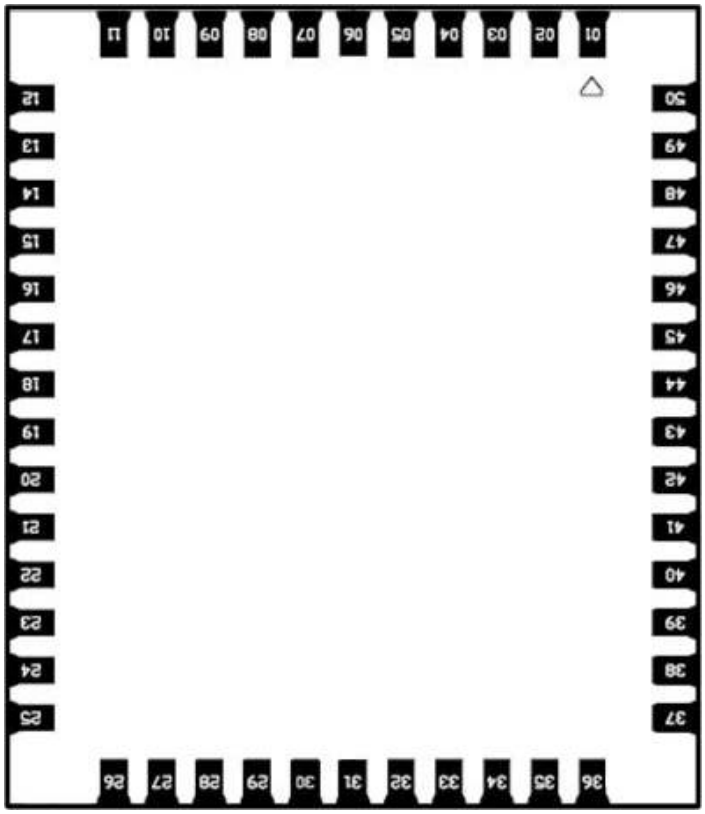
Conditions : VBAT=3.6V ; VDDIO=3.3V ; Temp:25°C

Feature	**Description**		
General Specification			
Bluetooth Standard	Bluetooth V4.1 of 1, 2 and 3 Mbps.		
Host Interface	UART		
Antenna Reference	Small antennas with 0~2 dBi peak gain		
Frequency Band	2402 MHz ~ 2480 MHz		
Number of Channels	79 channels		
Modulation	FHSS, GFSK, DPSK, DQPSK		
RF Specification			
	Min.	**Typical.**	**Max.**
Output Power (Class 1.5)		10 dBm	
Output Power (Class 2)		2 dBm	
Sensitivity @ BER=0.1% for GFSK (1Mbps)		-86 dBm	
Sensitivity @ BER=0.01% for π/4-DQPSK (2Mbps)		-86 dBm	
Sensitivity @ BER=0.01% for 8DPSK (3Mbps)		-80 dBm	
Maximum Input Level	GFSK (1Mbps):-20dBm		
	π/4-DQPSK (2Mbps) :-20dBm		
	8DPSK (3Mbps) :-20dBm		

7. Pin Assignments

7.1 Pin Outline

< TOP VIEW >



7.2 Pin Definition

NO	Name	Type	Description
1	GND	—	Ground connections
2	WL/BT_ANT0	I/O	RF I/O port0
3	GND	—	Ground connections
4	GND	—	Ground connections
5	GND	—	Ground connections
6	GND	—	Ground connections
7	GND	—	Ground connections
8	GND	—	Ground connections
9	WL_ANT1	I/O	RF I/O port1
10	GND	—	Ground connections
11	GND	—	Ground connections
12	PCIE_PERST	I	PCIE system reset
13	XTAL_OUT	O	External Crystal out

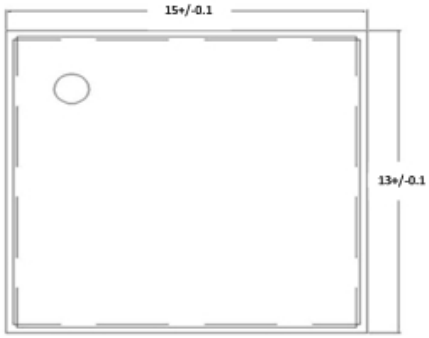
14	XTAL_IN	I	External Crystal in/ Single clock source in
15	WL_REG_ON	I	Low asserting reset for WiFi core
16	WL_HOST_WAKE	O	WLAN to wake-up HOST
17	SDIO_DATA_CMD	I/O	SDIO command line
18	SDIO_DATA_CLK	I/O	SDIO clock line
19	SDIO_DATA_3	I/O	SDIO data line 3
20	SDIO_DATA_2	I/O	SDIO data line 2
21	SDIO_DATA_0	I/O	SDIO data line 0
22	SDIO_DATA_1	I/O	SDIO data line 1
23	GND	—	Ground connections
24	PCIE_PME_L	O	PCIE power management event output
25	VIN_LDO	P	Internal Buck voltage generation pin
26	VIN_LDO_OUT	P	Internal Buck voltage generation pin
27	PCM_SYNC	I/O	PCM sync signal
28	PCM_IN	I	PCM data input
29	PCM_OUT	O	PCM Data output
30	PCM_CLK	I/O	PCM clock
31	LPO	I	External Low Power Clock input (32.768KHz)
32	GND	—	Ground connections
33	PCIE_REFCLK_N	I	PCIE differential clock inputs 100MHz differential
34	VDDIO	P	I/O Voltage supply input
35	PCIE_REFCLK_P	I	PCIE differential clock inputs 100MHz differential
36	VBAT	P	Main power voltage source input
37	PCIE_CLKREQ_L	O	PCIE clock request signal
38	BT_REG_ON	I	Low asserting reset for Bluetooth core
39	GND	—	Ground connections
40	UART_TXD	O	Bluetooth UART interface
41	UART_RXD	I	Bluetooth UART interface
42	UART_RTS_N	O	Bluetooth UART interface
43	UART_CTS_N	I	Bluetooth UART interface
44	PCIE_RDN	I	PCIE receiver differential pair
45	PCIE_RDP	I	PCIE receiver differential pair
46	PCIE_TDN	O	PCIE transmitter differential pair
47	PCIE_TDP	O	PCIE transmitter differential pair
48	GPIO8_9	I	Mode selection, 1=PCIE mode , 0=SDIO mode
49	BT_WAKE	I	HOST wake-up Bluetooth device
50	BT_HOST_WAKE	O	Bluetooth device to wake-up HOST

8. Dimensions

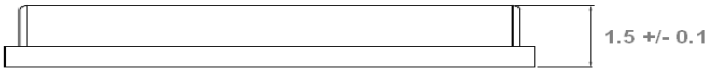
8.1 Physical Dimensions

(Unit: mm)

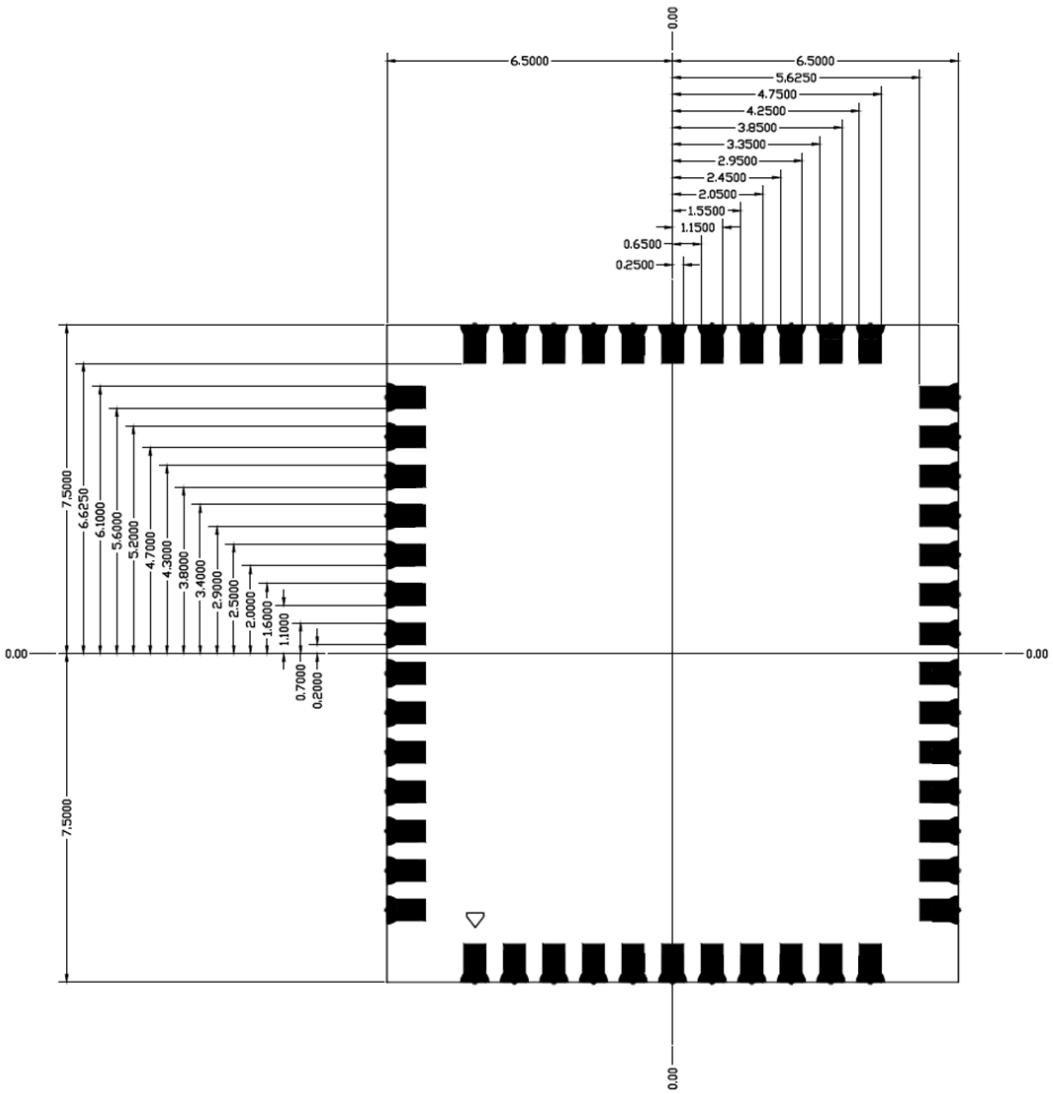
< TOP VIEW >



< Side View >



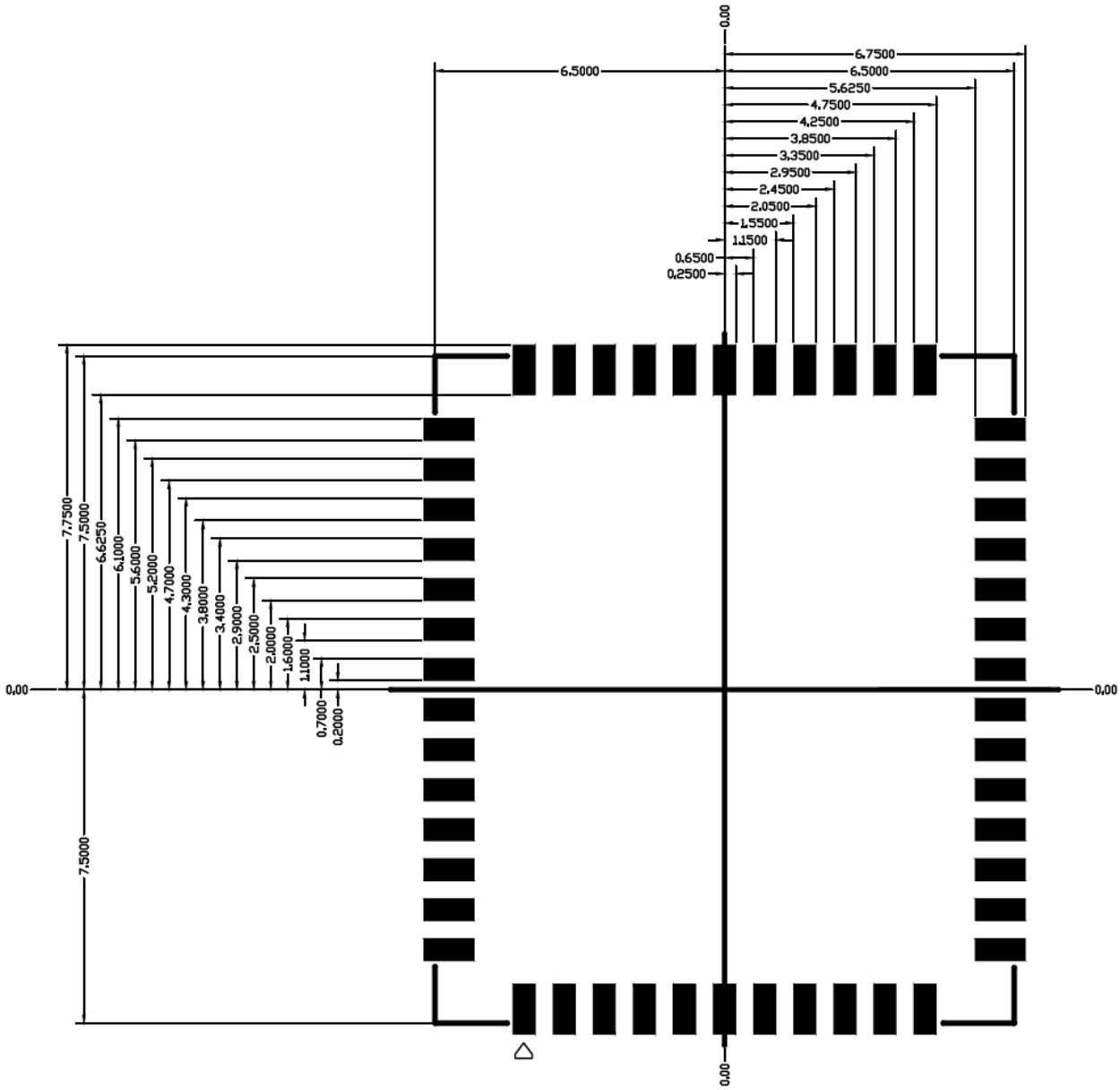
< TOP VIEW >



8.2 Layout Recommendation

(Unit: mm)

< TOP VIEW >



9. External clock reference

External LPO signal characteristics

Parameter	Specification	Units
Nominal input frequency	32.768	kHz
Frequency accuracy	±30	ppm
Duty cycle	30 - 70	%
Input signal amplitude	1600 to 3300	mV, p-p
Signal type	Square-wave or sine-wave	-
Input impedance	>100k <5	Ω pF
Clock jitter (integrated over 300Hz – 15KHz)	<1	Hz
Output high voltage	0.7Vio - Vio	V

9.1 SDIO Pin Description

The module supports SDIO version 3.0 for all 1.8V 4-bit UHSI speeds: SDR50(100 Mbps),SDR104(208MHz) and DDR50(50MHz, dual rates) in addition to the 3.3V default speed(25MHz) and high speed (50 MHz). It has the ability to stop the SDIO clock and map the interrupt signal into a GPIO pin. This 'out-of-band' interrupt signal notifies the host when the WLAN device wants to turn on the SDIO interface. The ability to force the control of the gated clocks from within the WLAN chip is also provided.

- ❖ Function 0 Standard SDIO function (Max BlockSize / ByteCount = 32B)
- ❖ Function 1 Backplane Function to access the internal System On Chip (SOC) address space (Max BlockSize / ByteCount = 64B)
- ❖ Function 2 WLAN Function for efficient WLAN packet transfer through DMA (Max BlockSize/ByteCount=512B)

SDIO Pin Description

SD 4-Bit Mode	
DATA0	Data Line 0
DATA1	Data Line 1 or Interrupt
DATA2	Data Line 2 or Read Wait
DATA3	Data Line 3
CLK	Clock
CMD	Command Line

10. Host Interface Timing Diagram

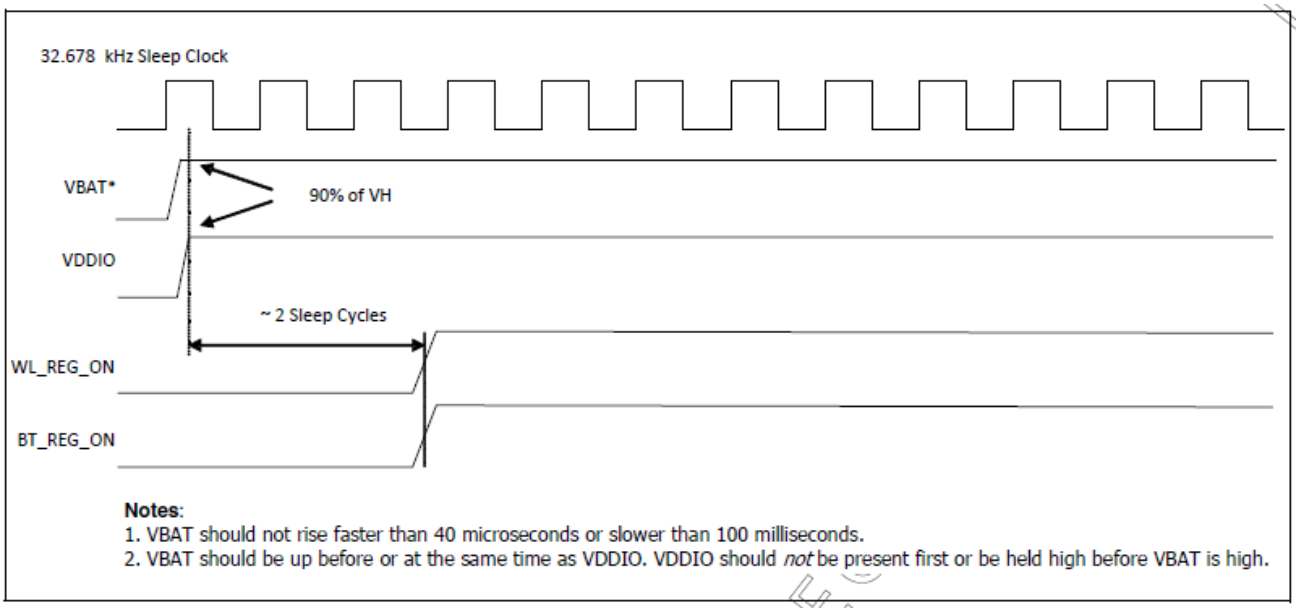
10.1 Power-up Sequence Timing Diagram

The module has signals that allow the host to control power consumption by enabling or disabling the Bluetooth, WLAN and internal regulator blocks. These signals are described below.

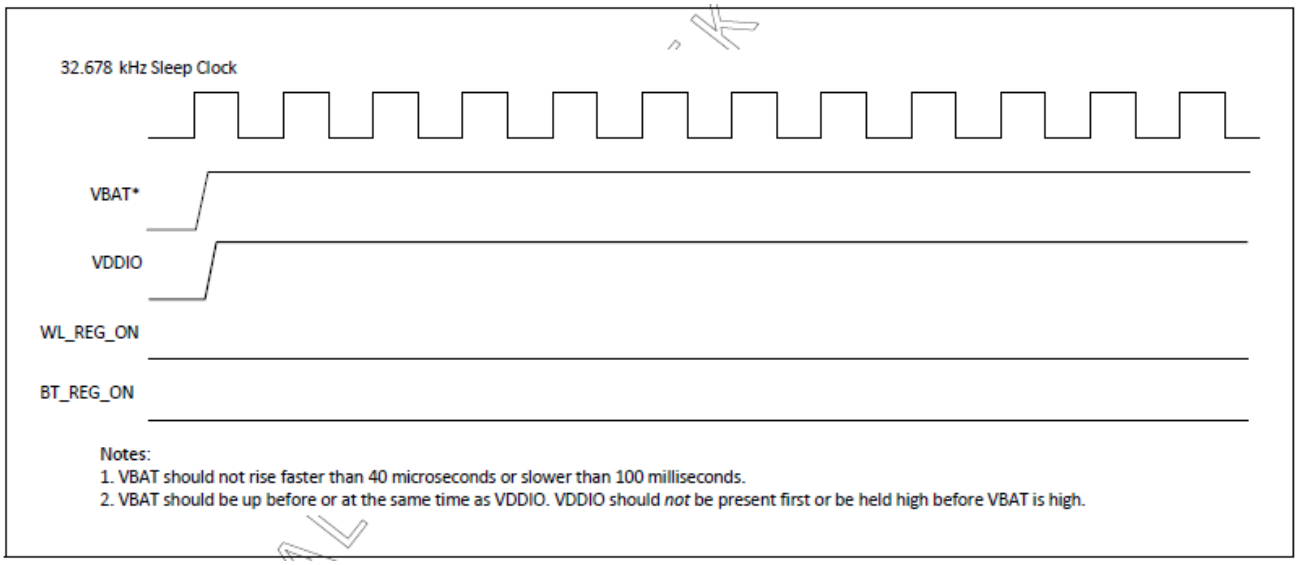
Additionally, diagrams are provided to indicate proper sequencing of the signals for carious operating states. The timing value indicated are minimum required values: longer delays are also acceptable.

※ WL_REG_ON: Used by the PMU to power up or power down the internal regulators used by the WLAN section. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset.

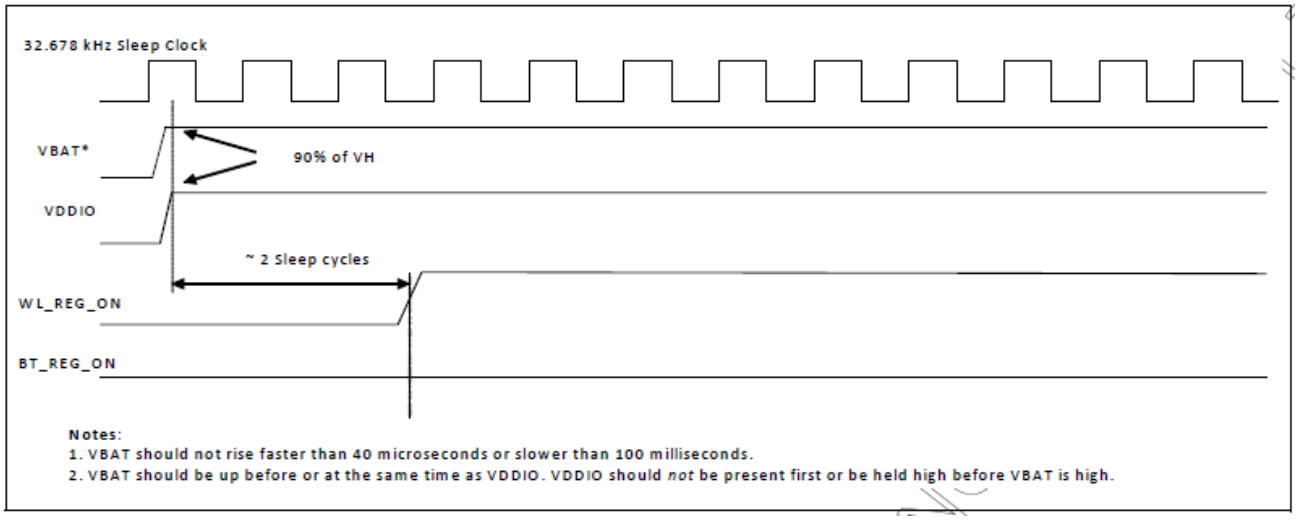
※ BT_REG_ON: Used by the PMU to power up or power down the internal regulators used by the BT section. Low asserting reset for Bluetooth. This pin has no effect on WLAN and does not control any PMU functions. This pin must be driven high or low (not left floating).



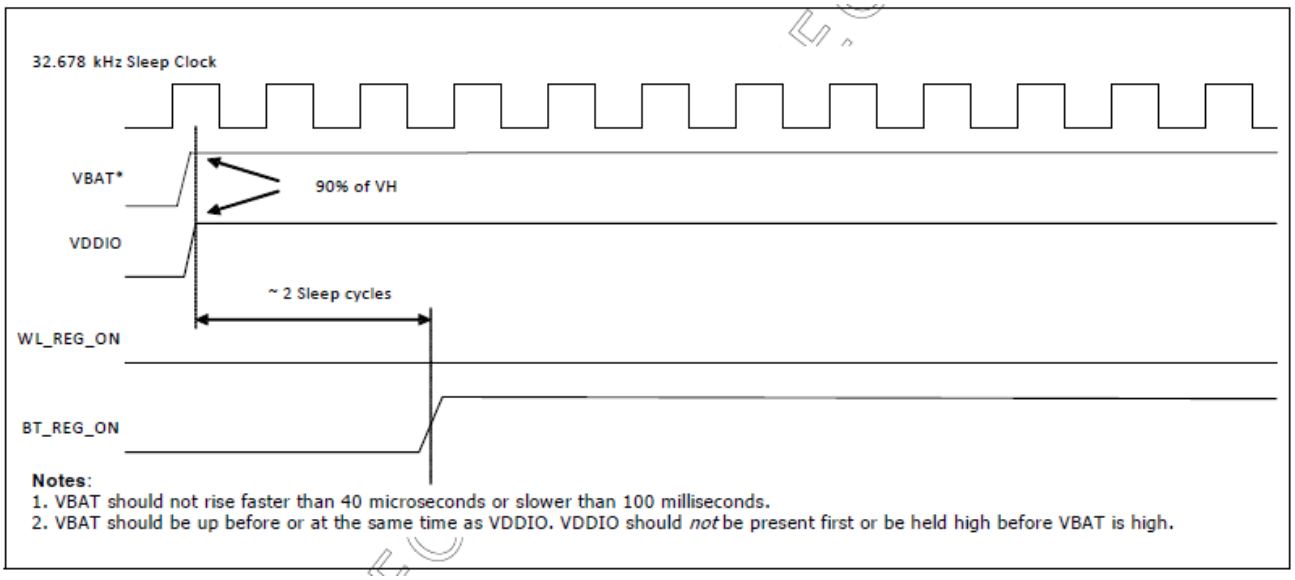
WLAN=ON, Bluetooth=ON



WLAN=OFF, Bluetooth=OFF

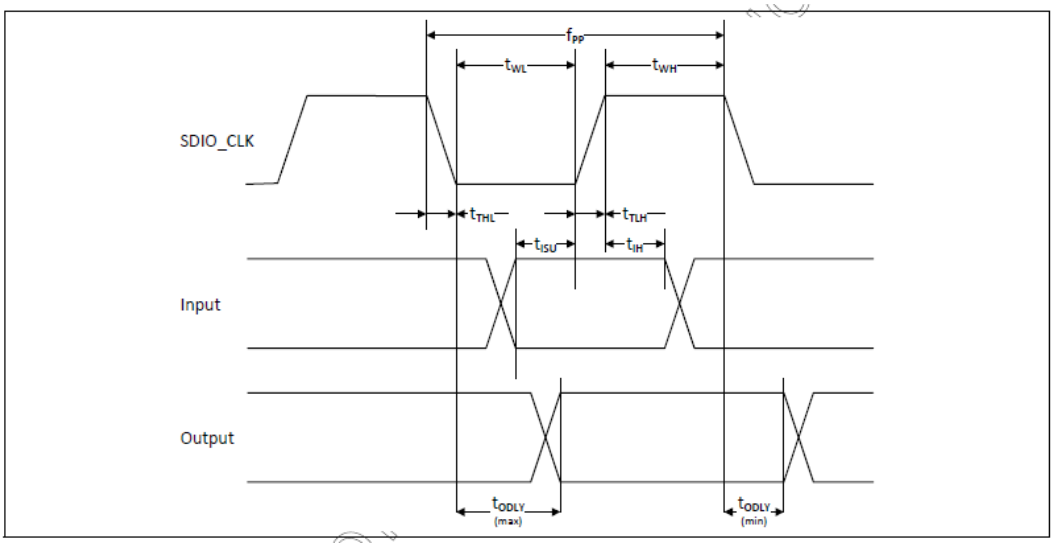


WLAN=ON, Bluetooth=OFF



WLAN=OFF, Bluetooth=ON

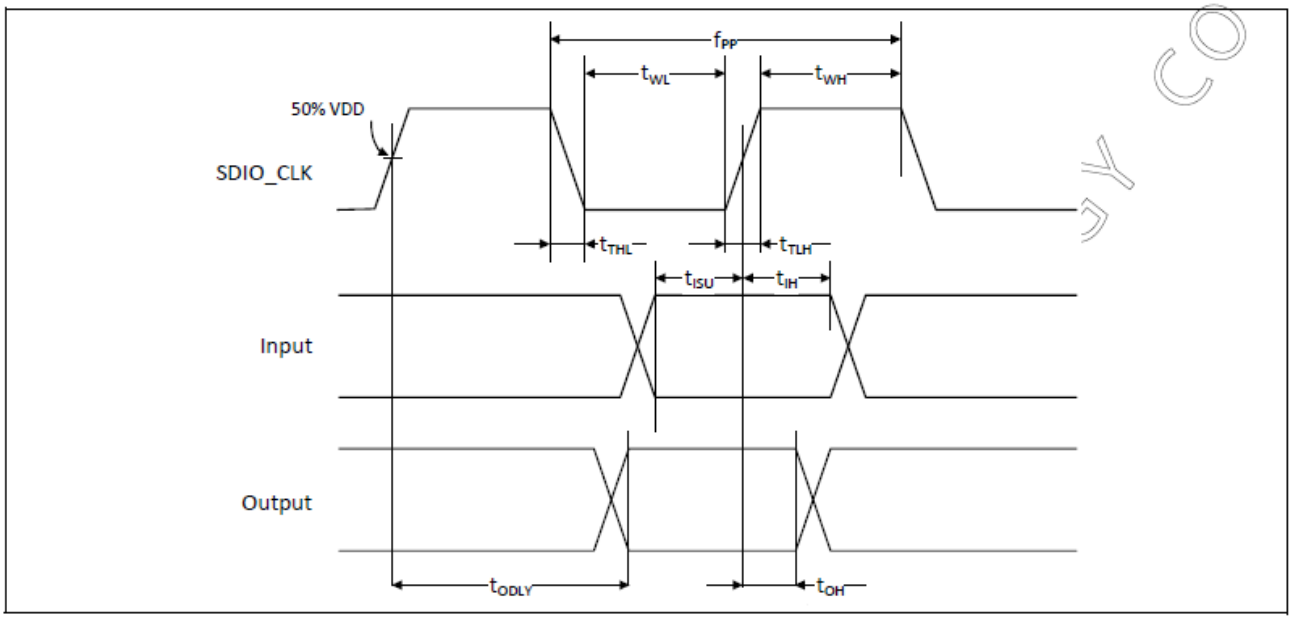
10.2 SDIO Default Mode Timing Diagram



Parameter	Symbol	Minimum	Typical	Maximum	Unit
SDIO CLK (All values are referred to minimum VIH and maximum VIL[b])					
Frequency – Data Transfer mode	fPP	0	–	25	MHz
Frequency – Identification mode	fOD	0	–	400	kHz
Clock low time	tWL	10	–	–	ns
Clock high time	tWH	10	–	–	ns
Clock rise time	tTLH	–	–	10	ns
Clock low time	tTHL	–	–	10	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup time	tISU	5	–	–	ns
Input hold time	tIH	5	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer mode	tODLY	0	–	14	ns
Output delay time – Identification mode	tODLY	0	–	50	ns

a. Timing is based on CL ≤ 40pF load on CMD and Data.
b. min(Vih) = 0.7 × VDDIO and max(Vil) = 0.2 × VDDIO.

10.3 SDIO High Speed Mode Timing Diagram



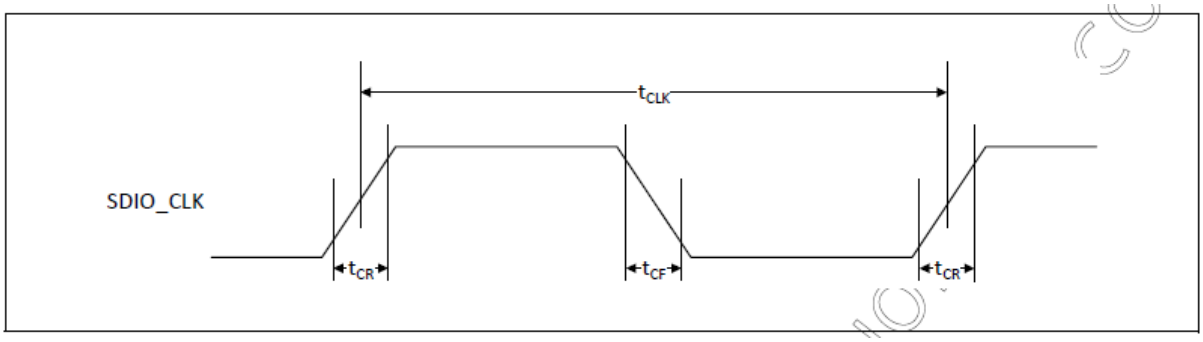
Parameter	Symbol	Minimum	Typical	Maximum	Unit
SDIO CLK (all values are referred to minimum VIH and maximum VIL[b])					
Frequency – Data Transfer Mode	fPP	0	–	50	MHz
Frequency – Identification Mode	fOD	0	–	400	kHz
Clock low time	tWL	7	–	–	ns
Clock high time	tWH	7	–	–	ns
Clock rise time	tTLH	–	–	3	ns
Clock low time	tTHL	–	–	3	ns
Inputs: CMD, DAT (referenced to CLK)					
Input setup Time	tISU	6	–	–	ns
Input hold Time	tIH	2	–	–	ns
Outputs: CMD, DAT (referenced to CLK)					
Output delay time – Data Transfer Mode	tODLY	–	–	14	ns
Output hold time	tOH	2.5	–	–	ns
Total system capacitance (each line)	CL	–	–	40	pF

a. Timing is based on CL ≤ 40 pF load on CMD and Data.
b. min(Vih) = 0.7 × VDDIO and max(Vil) = 0.2 × VDDIO.

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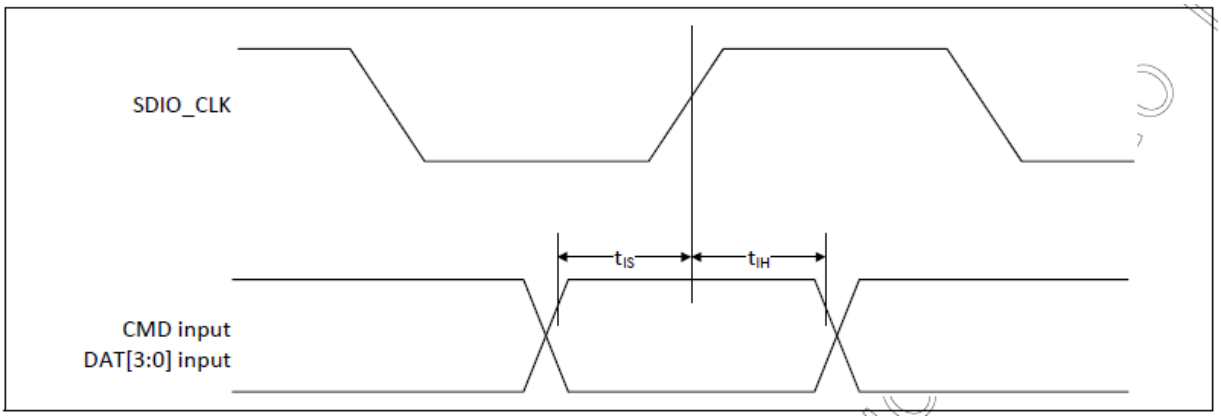
10.4 SDIO Bus Timing Specifications in SDR Modes

Clock timing(SDR Modes)



Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t_{CLK}	40	–	ns	SDR12 mode
		20	–	ns	SDR25 mode
		10	–	ns	SDR50 mode
		4.8	–	ns	SDR104 mode
–	t_{CR}, t_{CF}	–	0.2 × t_{CLK}	ns	t_{CR}, t_{CF} < 2.00 ns (max) @100 MHz, C_{CARD} = 10 pF t_{CR}, t_{CF} < 0.96 ns (max) @208 MHz, C_{CARD} = 10 pF
Clock duty	–	30	70	%	–

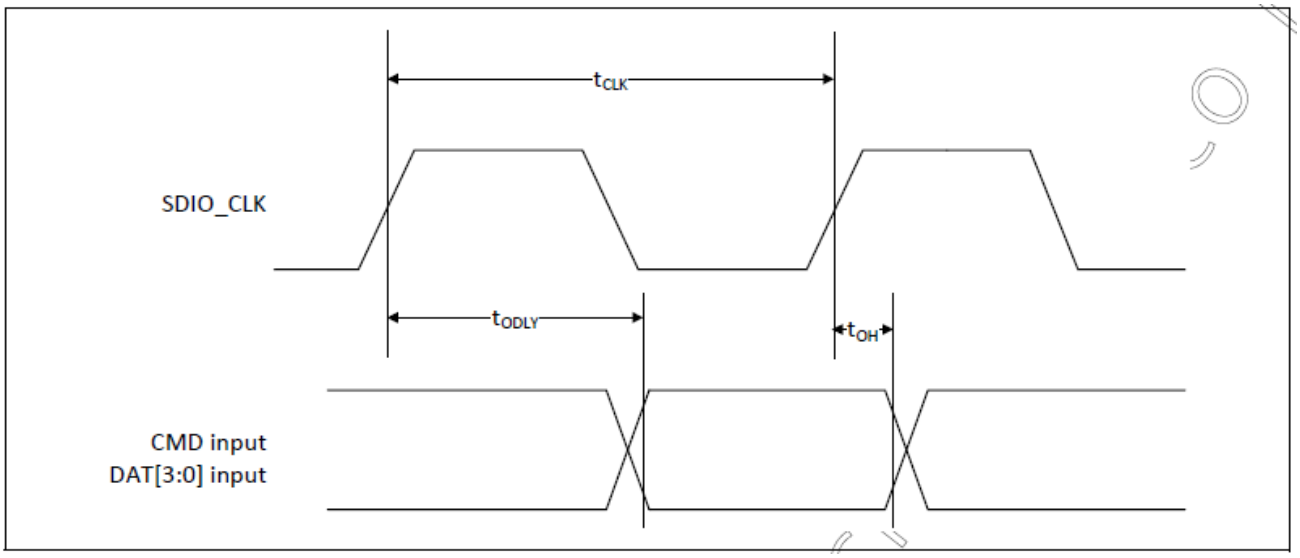
Card Input timing (SDR Modes)



Symbol	Minimum	Maximum	Unit	Comments
SDR104 Mode				
t_{IS}	1.70[a]	–	ns	C_{CARD} = 10 pF, VCT = 0.975V
t_{IH}	0.80	–	ns	C_{CARD} = 5 pF, VCT = 0.975V
SDR50 Mode				
t_{IS}	3.00	–	ns	C_{CARD} = 10 pF, VCT = 0.975V
t_{IH}	0.80	–	ns	C_{CARD} = 5 pF, VCT = 0.975V

a. SDIO 3.0 specification value is 1.40 ns.

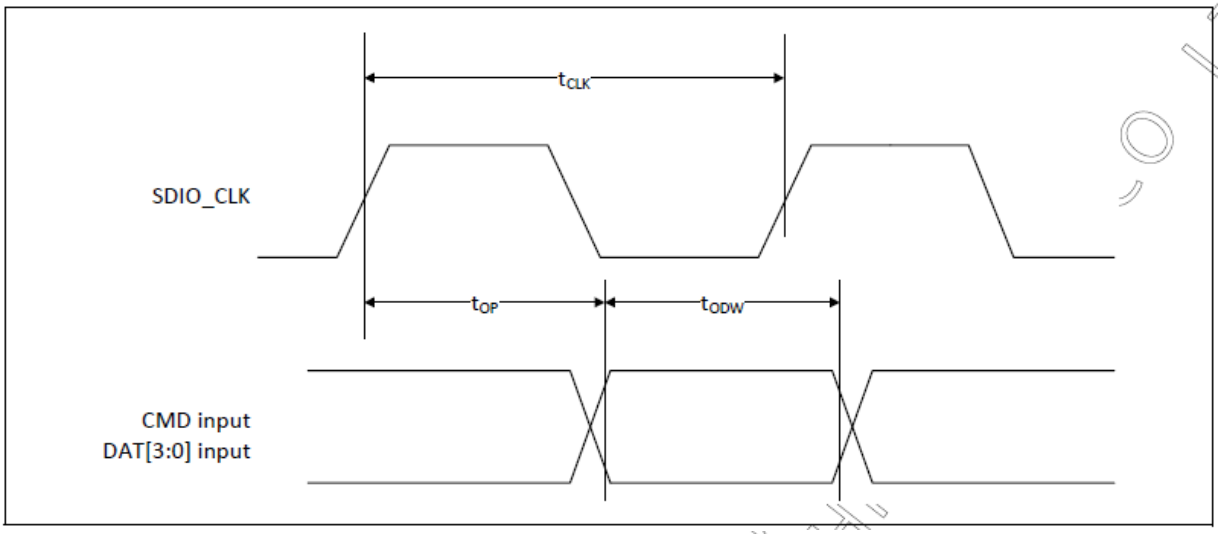
Card output timing (SDR Modes up to 100MHz)



Symbol	Minimum	Maximum	Unit	Comments
t_{ODLY}	–	7.85[a]	ns	t_{CLK} ≥ 10 ns C_L= 30 pF using driver type B for SDR50
t_{ODLY}	–	14.0	ns	t_{CLK} ≥ 20 ns C_L= 40 pF using for SDR12, SDR25
t_{OH}	1.5	–	ns	Hold time at the t_{ODLY} (min) C_L= 15 pF

a. SDIO 3.0 specification value is 7.5 ns.

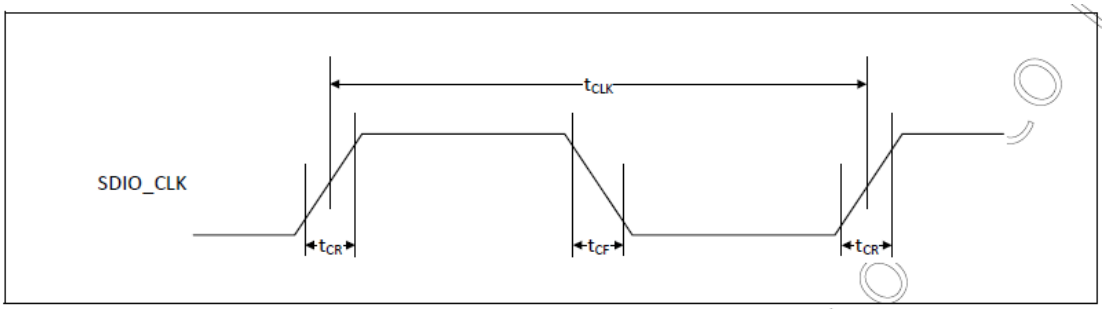
Card output timing (SDR Modes 100MHz to 208MHz)



Symbol	Minimum	Maximum	Unit	Comments
t_{OP}	0	2	UI	Card output phase
Δt_{OP}	–350	+1550	ps	Delay variation due to temp change after tuning
t_{ODW}	0.60	–	UI	t_{ODW}=2.88 ns @208 MHz

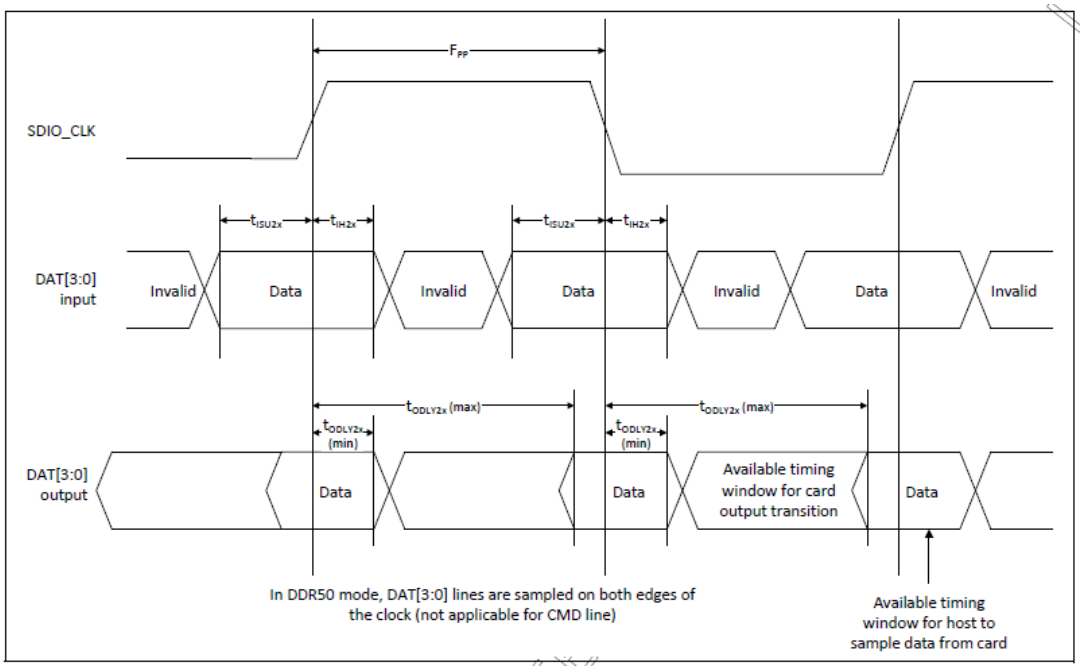
- Δt_{OP} = +1550 ps for junction temperature of Δt_{OP} = 90 degrees during operation
- Δt_{OP} = –350 ps for junction temperature of Δt_{OP} = –20 degrees during operation
- Δt_{OP} = +2600 ps for junction temperature of Δt_{OP} = –20 to +125 degrees during operation

10.5 SDIO Bus Timing Specifications in DDR50 Mode



Parameter	Symbol	Minimum	Maximum	Unit	Comments
–	t_{CLK}	20	–	ns	DDR50 mode
–	t_{CR},t_{CF}	–	0.2 × tCLK	ns	t_{CR}, t_{CF} < 4.00 ns (max) @50 MHz, C_{CARD} = 10 pF
Clock duty	–	45	55	%	–

Data Timing



Parameter	Symbol	Minimum	Maximum	Unit	Comments
Input CMD					
Input setup time	t_{ISU}	6	–	ns	C_{CARD} < 10pF (1 Card)
Input hold time	t_{IH}	0.8	–	ns	C_{CARD} < 10pF (1 Card)
Output CMD					
Output delay time	t_{ODLY}	–	13.7	ns	C_{CARD} < 30pF (1 Card)
Output hold time	t_{OH}	1.5	–	ns	C_{CARD} < 15pF (1 Card)
Input DAT					
Input setup time	t_{ISU2x}	3	–	ns	C_{CARD} < 10pF (1 Card)
Input hold time	t_{IH2x}	0.8	–	ns	C_{CARD} < 10pF (1 Card)
Output DAT					
Output delay time	t_{ODLY2x}	–	7.85[a]	ns	C_{CARD} < 25pF (1 Card)
Output hold time	t_{ODLY2x}	1.5	–	ns	C_{CARD} < 15pF (1 Card)

a. SDIO 3.0 specification value is 7.0 ns.

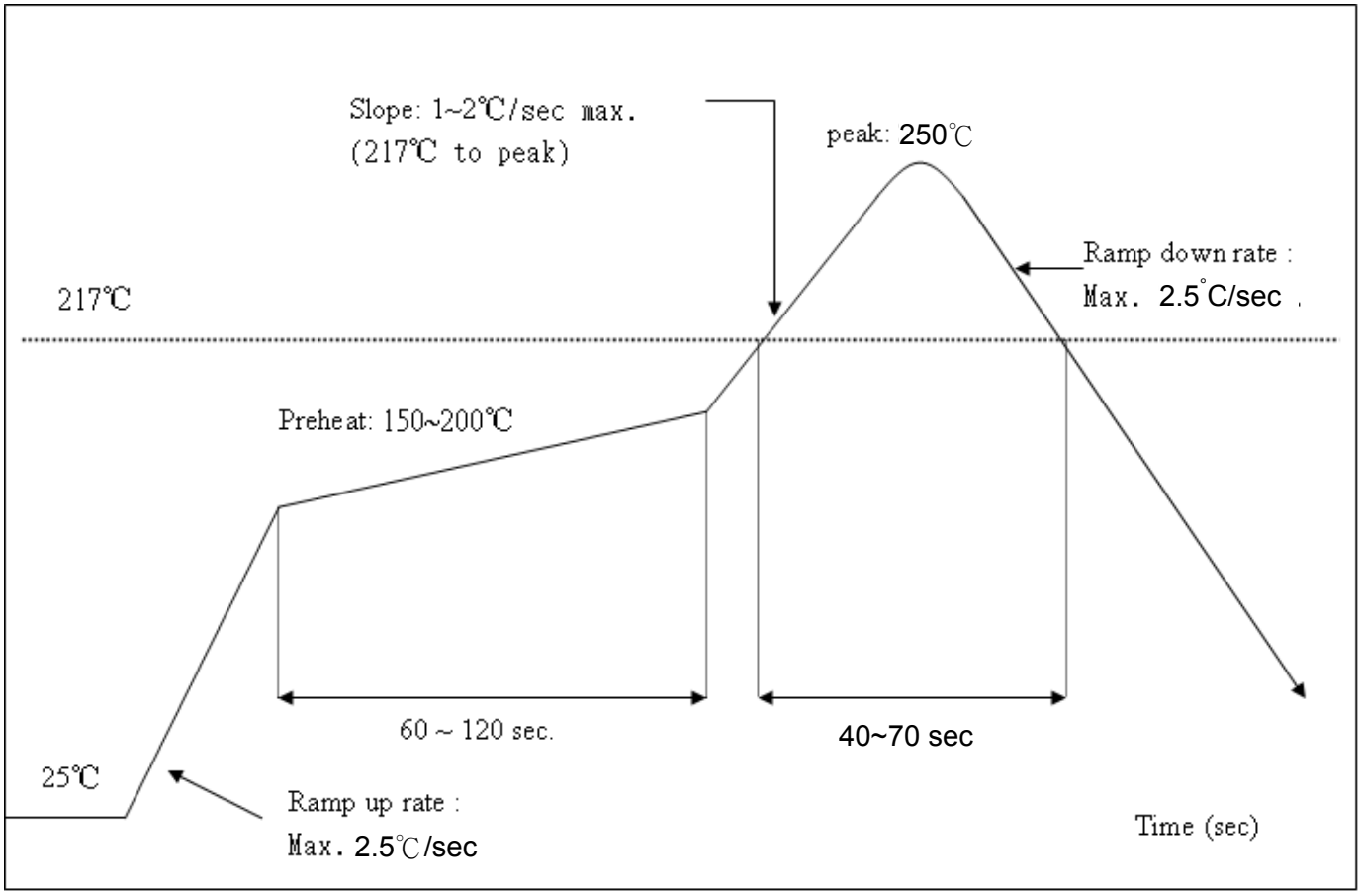
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11. Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <250°C

Number of Times : ≤2 times



12. Package Information

12.1Label

Label A→ Anti-static and humidity notice



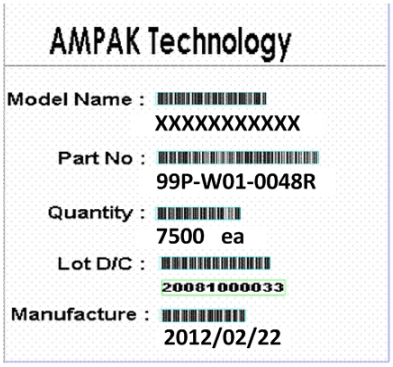
Label B→ MSL caution / Storage Condition



Label C→ Inner box label .

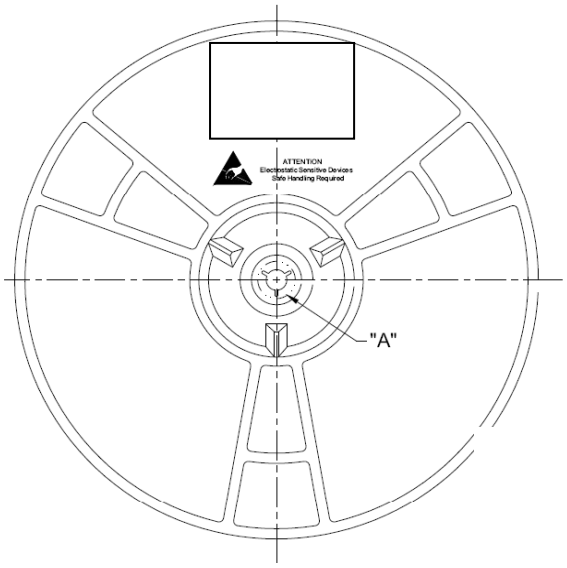


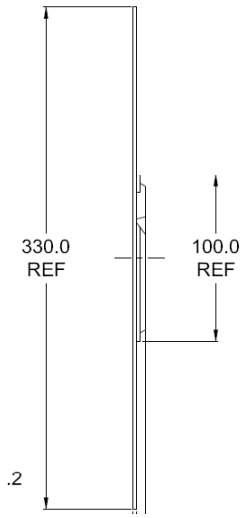
Label D→ Carton box label .

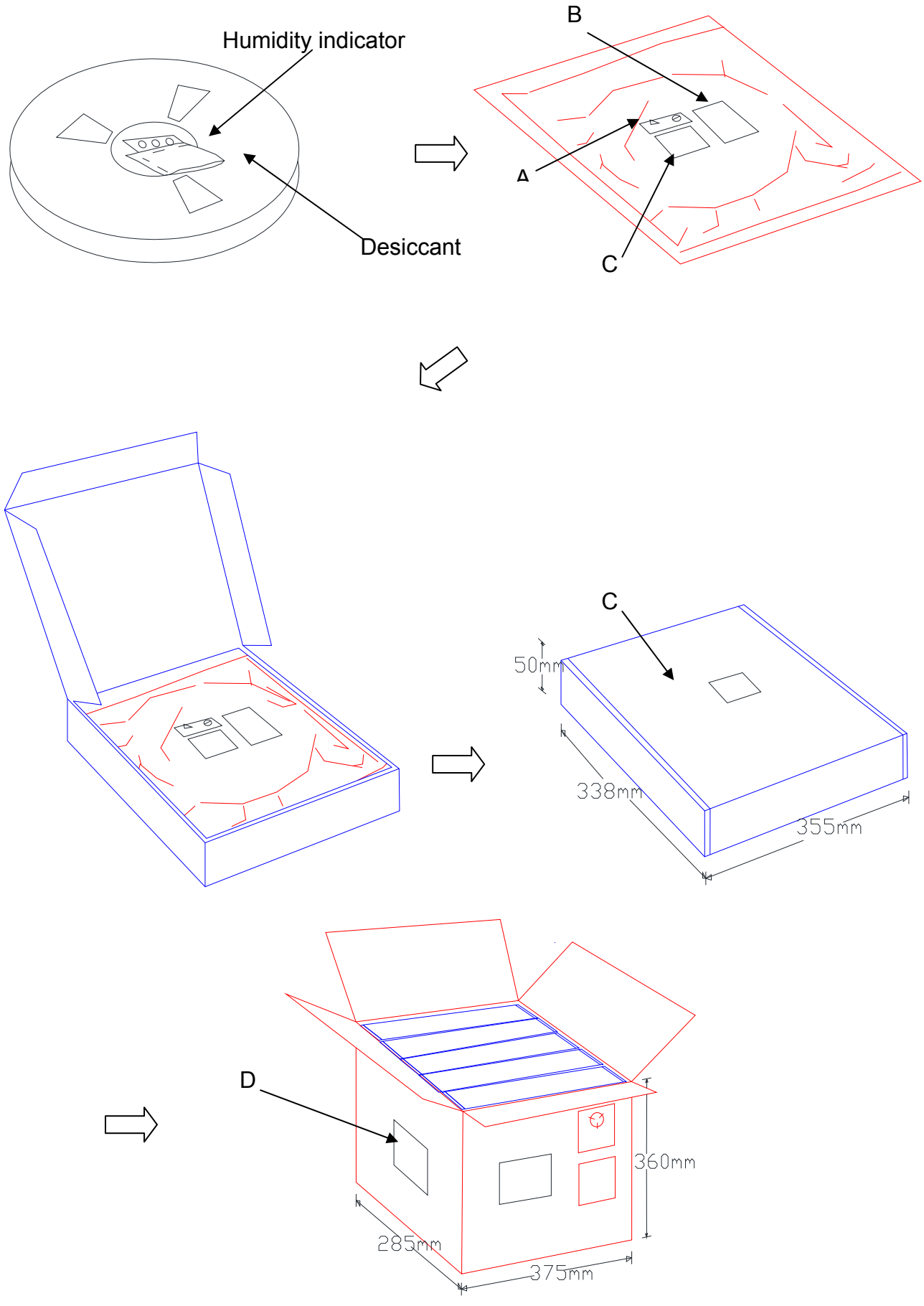


12.2 Dimension

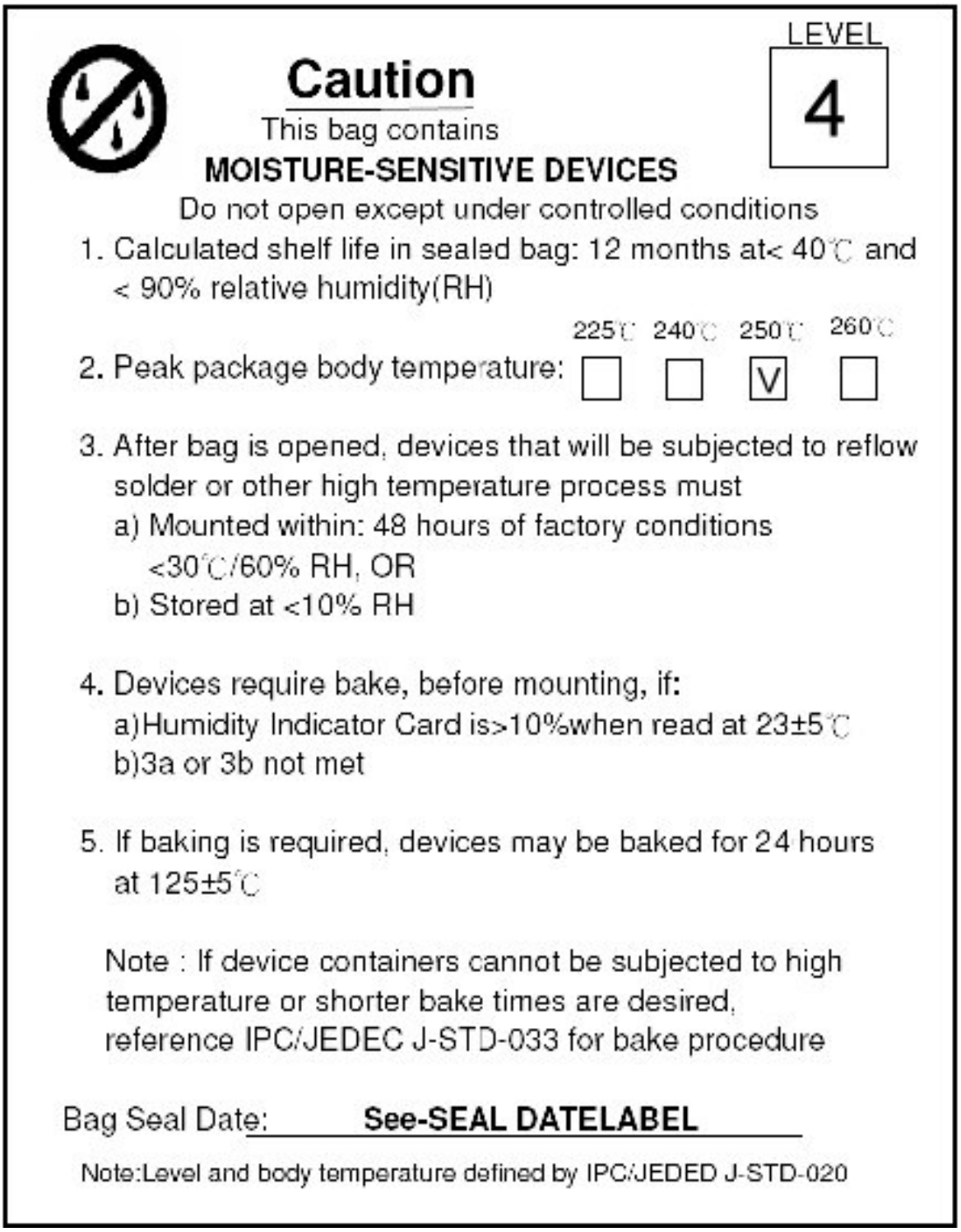
1. 10 sprocket hole pitch cumulative tolerance ±0.20.
2. Carrier camber is within 1 mm in 250 mm.
3. Material : Black Conductive Polystyrene Alloy.
4. All dimensions meet EIA-481-D requirements.
5. Thickness : 0.30±0.05mm.
6. Packing length per 22" reel : 98.5 Meters.(1:3)
7. Component load per 13" reel : 1500 pcs.






Humidity indicator
Desiccant
B
A
C
C
50mm
338mm
355mm
D
360mm
285mm
375mm

12.3 MSL Level / Storage Condition



Caution

This bag contains

MOISTURE-SENSITIVE DEVICES

Do not open except under controlled conditions

LEVEL 4

1. Calculated shelf life in sealed bag: 12 months at< 40℃ and < 90% relative humidity(RH)
2. Peak package body temperature: 225℃ ☐ 240℃ ☐ 250℃ ☑ 260℃ ☐
3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must
   a) Mounted within: 48 hours of factory conditions <30℃/60% RH, OR
   b) Stored at <10% RH
4. Devices require bake, before mounting, if:
   a) Humidity Indicator Card is>10%when read at 23±5℃
   b) 3a or 3b not met
5. If baking is required, devices may be baked for 24 hours at 125±5℃

Note : If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure

Bag Seal Date: **See-SEAL DATELABEL**

Note:Level and body temperature defined by IPC/JEDED J-STD-020

※NOTE : Accumulated baking time should not exceed 96hrs